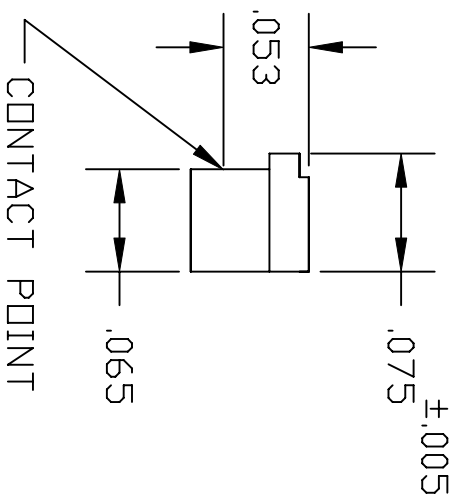
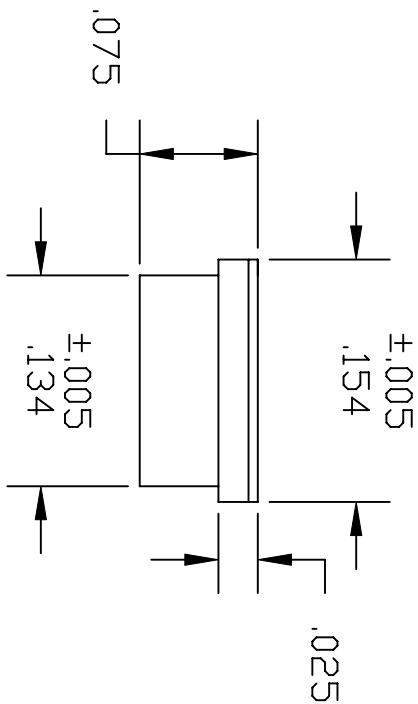


DESCRIPTION: 2MM SHUNT LOW PROFILE, .075" 15 MICROINCH GOLD



MATERIAL: HOUSING: HIGH TEMP, (PA-6T) 260° PROCESS TEMP.

CONTACT: BERYLLIUM COPPER

PLATING: 15 MICRO-INCHES PALLADIUM/NICKEL WITH GOLD FLASH OVERALL

ELECTRICALS: CURRENT RATING: 1.0 AMPERE MAX.

CONTACT RESISTANCE: 20 MILLIOHM MAX.

DIELECTRIC WITHSTANDING: 250 VAC @SEA LEVEL

INSULATION RESISTANCE: 10,000 MOHMS MIN.

OPERATING TEMP: -55°C TO 105°C



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OR USED AS THE BASIS FOR THE
MANUFACTURE OF APPARATUS
WITHOUT WRITTEN PERMISSION.

DRAWN:
PAM JENKINS

DATE:
12-12-06

CHECKED:

DATE:

SCALE:

SHEET
1 OF 1

REV
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DWG NO.

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